

1/3-Inch 1.2 Mp CMOS Digital Image Sensor with Global Shutter

AR0134CS Datasheet, Rev. 8

For the latest datasheet revision, please visit www.onsemi.com

Features

- ON Semiconductor's 3rd Generation Global Shutter Technology
- Superior low-light performance
- HD video (720p60)
- Video/Single Frame mode
- Flexible row-skip modes
- On-chip AE and statistics engine
- Parallel and serial output
- · Support for external LED or flash
- Auto black level calibration
- · Context switching

Applications

- Scene processing
- · Scanning and machine vision
- 720p60 video applications

General Description

ON Semiconductor's AR0134 is a 1/3-inch 1.2 Mp CMOS digital image sensor with an active-pixel array of 1280H x 960V. It is designed for low light performance and features a global shutter for accurate capture of moving scenes. It includes sophisticated camera functions such as auto exposure control, windowing, scaling, row skip mode, and both video and single frame modes. It is programmable through a simple two-wire serial interface. The AR0134 produces extraordinarily clear, sharp digital pictures, and its ability to capture both continuous video and single frames makes it the perfect choice for a wide range of applications, including scanning and industrial inspection.

Table 1: Key Parameters

Parameter		Typical Value		
Optical format		1/3-inch (6 mm)		
Active pixels		1280H x 960V = 1.2 Mp		
Pixel size		3.75 μm		
Color filter array		RGB Bayer or Monochrome		
Shutter type		Global shutter		
Input clock range	2	6 – 50 MHz		
Output pixel clos	ck (maximum)	74.25 MHz		
Output	Serial	HiSPi		
Output Parallel		12-bit		
Frame rate Full resolution		54 fps		
720p		60 fps		
Responsivity	Monochrome	6.1 V/lux-sec		
Responsivity	Color	5.3 V/lux-sec		
SNR _{MAX}	-	38.6 dB		
Dynamic range		64 dB		
	I/O	1.8 or 2.8 V		
Supply	Digital	1.8 V		
voltage	Analog	2.8 V		
	HiSPi	0.4 V		
Power consumpt	ion	<400 mW		
Operating temperature		-30°C to +70°C (ambient) -30°C to +80°C (junction)		
		9 x 9 mm 64-pin iBGA		
Package options		10 x 10 mm 48-pin iLCC		
		Bare die		



Ordering Information

Table 2: Available Part Numbers

Part Number	Product Description	Orderable Product Attribute Description
AR0134CSSC00SPCA0-DPBR	Color, iLCC (Parallel)	Dry Pack with Protective Film, Double Side BBAR Glass
AR0134CSSC00SPCA0-DRBR	Color, iLCC (Parallel)	Dry Pack without Protective Film, Double Side BBAR Glass
AR0134CSSC00SPCA0-TPBR	Color, iLCC (Parallel)	Tape & Reel with Protective Film, Double Side BBAR Glass
AR0134CSSC00SPCA0-TRBR	Color, iLCC (Parallel)	Tape & Reel without Protective Film, Double Side BBAR Glass
AR0134CSSC00SPCAD-GEVK	Color, iLCC (Parallel), Demo Kit	
AR0134CSSC00SPCAH-GEVB	Color, iLCC (Parallel), Head Board	
AR0134CSSC00SUEA0-DPBR1	Color, iBGA	Dry Pack with Protective Film, Double Side BBAR Glass
AR0134CSSC00SUEA0-DRBR	Color, iBGA	Dry Pack without Protective Film, Double Side BBAR Glass
AR0134CSSC00SUEA0-TPBR	Color, iBGA	Tape & Reel with Protective Film, Double Side BBAR Glass
AR0134CSSC00SUEA0-TRBR	Color, iBGA	Tape & Reel without Protective Film, Double Side BBAR Glass
AR0134CSSC00SUEAD3-GEVK	Color, iBGA Demo3 Kit	
AR0134CSSC00SUEAD-GEVK	Color, iBGA Demo Kit	
AR0134CSSC00SUEAH-GEVB	Color, iBGA Head Board	
AR0134CSSC25SUEA0-DPBR	Color, iBGA, 25deg shift	Dry Pack with Protective Film, Double Side BBAR Glass
AR0134CSSC25SUEA0-DRBR	Color, iBGA, 25deg shift	Dry Pack without Protective Film, Double Side BBAR Glass
AR0134CSSC25SUEA0-TPBR	Color, iBGA, 25deg shift	Tape & Reel with Protective Film, Double Side BBAR Glass
AR0134CSSC25SUEA0-TRBR	Color, iBGA, 25deg shift	Tape & Reel without Protective Film, Double Side BBAR Glass
AR0134CSSM00SPCA0-DPBR	Mono,	Dry Pack with Protective Film, Double Side BBAR Glass
AR0134CSSM00SPCA0-DRBR	Mono, iLCC (Parallel)	Dry Pack without Protective Film, Double Side BBAR Glass
AR0134CSSM00SPCA0-TPBR	Mono, iLCC (Parallel)	Tape & Reel with Protective Film, Double Side BBAR Glass
AR0134CSSM00SPCA0-TRBR	Mono, iLCC (Parallel)	Tape & Reel without Protective Film, Double Side BBAR Glass
AR0134CSSM00SPCAD-GEVK	Mono, iLCC (Parallel) Demo Kit	
AR0134CSSM00SPCAH-GEVB	Mono, iLCC (Parallel) Head Board	
AR0134CSSM00SUEA0-DPBR1	Mono, iBGA	Dry Pack with Protective Film, Double Side BBAR Glass
AR0134CSSM00SUEA0-DRBR	Mono, iBGA	Dry Pack without Protective Film, Double Side BBAR Glass
AR0134CSSM00SUEA0-TPBR	Mono, iBGA	Tape & Reel with Protective Film, Double Side BBAR Glass
AR0134CSSM00SUEA0-TRBR	Mono, iBGA	Tape & Reel without Protective Film, Double Side BBAR Glass
AR0134CSSM00SUEAD3-GEVK	Mono, iBGA, Demo3 Kit	
AR0134CSSM00SUEAD-GEVK	Mono, iBGA, Demo Kit	
AR0134CSSM00SUEAH-GEVB	Mono, iBGA, Head Board	
AR0134CSSM25SPCA0-DRBR	Mono, iLCC (Parallel), 25deg shift	
AR0134CSSM25SPCA0-TPBR	Mono, iLCC (Parallel), 25deg shift	Tape & Reel with Protective Film, Double Side BBAR Glass
AR0134CSSM25SUEA0-DPBR	Mono, iBGA, Head Board	Dry Pack with Protective Film, Double Side BBAR Glass
AR0134CSSM25SUEA0-DRBR	Mono, iBGA, 25deg shift	Dry Pack without Protective Film, Double Side BBAR Glass
AR0134CSSM25SUEA0-TPBR	Mono, iBGA, 25deg shift	Tape & Reel with Protective Film, Double Side BBAR Glass
AR0134CSSM25SUEA0-TRBR	Mono, iBGA, 25deg shift	Tape & Reel without Protective Film, Double Side BBAR Glass
AR0134CSSM25SUEAD3-GEVK	Mono, iBGA, 25deg shift	
AR0134CSSM25SUEAD-GEVK	Mono, iBGA, 25deg shift Demo Kit	
AR0134CSSM25SUEAH-GEVB	Mono, iBGA, 25deg shift Head Board	
	l	I .

See the ON Semiconductor Device Nomenclature document (TND310/D) for a full description of the naming convention used for image sensors. For reference documentation, including information on evaluation kits, please visit our web site at www.onsemi.com.





Table of Contents

Features]
Applications	
General Description	
Ordering Information	
General Description	
Functional Overview	
Features Overview	
Pixel Data Format	
Configuration and Pinout	
Two-Wire Serial Register Interface	
Electrical Specifications	
Power-On Reset and Standby Timing	
Package Dimensions	
uckage Binichoronic	

General Description

The ON Semiconductor AR0134 can be operated in its default mode or programmed for frame size, exposure, gain, and other parameters. The default mode output is a full-resolution image at 54 frames per second (fps). It outputs 12-bit raw data, using either the parallel or serial (HiSPi) output ports. The device may be operated in video (master) mode or in frame trigger mode.

FRAME_VALID and LINE_VALID signals are output on dedicated pins, along with a synchronized pixel clock. A dedicated FLASH pin can be programmed to control external LED or flash exposure illumination.

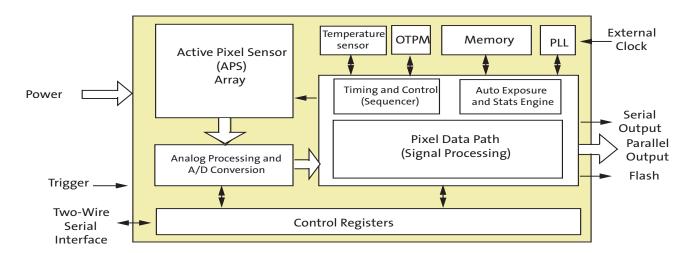
The AR0134 includes additional features to allow application-specific tuning: windowing, adjustable auto-exposure control, auto black level correction, on-board temperature sensor, and row skip and digital binning modes.

The sensor is designed to operate in a wide temperature range (-30°C to +70°C).

Functional Overview

The AR0134 is a progressive-scan sensor that generates a stream of pixel data at a constant frame rate. It uses an on-chip, phase-locked loop (PLL) that can be optionally enabled to generate all internal clocks from a single master input clock running between 6 and 50 MHz. The maximum output pixel rate is 74.25 Mp/s, corresponding to a clock rate of 74.25 MHz. Figure 1 shows a block diagram of the sensor.

Figure 1: Block Diagram



User interaction with the sensor is through the two-wire serial bus, which communicates with the array control, analog signal chain, and digital signal chain. The core of the sensor is a 1.2 Mp Active- Pixel Sensor array. The AR0134 features global shutter technology for accurate capture of moving images. The exposure of the entire array is controlled by programming the integration time by register setting. All rows simultaneously integrate light prior to readout. Once a row has been read, the data from the columns is sequenced through an analog signal chain (providing offset correction and gain), and then through an analog-to- digital converter (ADC). The output from the ADC is a 12-bit value for each pixel in the array. The ADC output passes through a digital



processing signal chain (which provides further data path corrections and applies digital gain). The pixel data are output at a rate of up to $74.25 \,\mathrm{Mp/s}$, in parallel to frame and line synchronization signals.

Features Overview

The AR0134 Global Sensor shutter has a wide array of features to enhance functionality and to increase versatility. A summary of features follows. Please refer to the AR0134 Developer Guide for detailed feature descriptions, register settings, and tuning guidelines and recommendations.

· Operating Modes

The AR0134 works in master (video), trigger (single frame), or Auto Trigger modes. In master mode, the sensor generates the integration and readout timing. In trigger mode, it accepts an external trigger to start exposure, then generates the exposure and readout timing. The exposure time is programmed through the two-wire serial interface for both modes. Trigger mode is not compatible with the HiSPi interface.

Window Control

Configurable window size and blanking times allow a wide range of resolutions and frame rates. Digital binning and skipping modes are supported, as are vertical and horizontal mirror operations.

Context Switching

Context switching may be used to rapidly switch between two sets of register values. Refer to the AR0134 Developer Guide for a complete set of context switchable registers.

Gain

The AR0134 Global Shutter sensor can be configured for analog gain of up to 8x, and digital gain of up to 8x.

• Automatic Exposure Control

The integrated automatic exposure control may be used to ensure optimal settings of exposure and gain are computed and updated every other frame. Refer to the AR0134 Developer Guide for more details.

HiSPi

The AR0134 Global Shutter image sensor supports two or three lanes of Streaming-SP or Packetized-SP protocols of ON Semiconductor's High-Speed Serial Pixel Interface.

PLI.

An on chip PLL provides reference clock flexibility and supports spread spectrum sources for improved EMI performance.

Reset

The AR0134 may be reset by a register write, or by a dedicated input pin.

• Output Enable

The AR0134 output pins may be tri-stated using a dedicated output enable pin.

• Temperature Sensor

The temperature sensor is only guaranteed to be functional when the AR0134 is initially powered-up or is reset at temperatures at or above 0°C.

- Black Level Correction
- Row Noise Correction
- Column Correction
- · Test Patterns

Several test patterns may be enabled for debug purposes. These include a solid color, color bar, fade to grey, and a walking 1s test pattern.



Pixel Data Format

Pixel Array Structure

The AR0134 pixel array is configured as 1412 columns by 1028 rows, (see Figure 2). The dark pixels are optically black and are used internally to monitor black level. Of the right 108 columns, 64 are dark pixels used for row noise correction. Of the top 24 rows of pixels, 12 of the dark rows are used for black level correction. There are 1296 columns by 976 rows of optically active pixels. While the sensor's format is 1280×960 , the additional active columns and active rows are included for use when horizontal or vertical mirrored readout is enabled, to allow readout to start on the same pixel. The pixel adjustment is always performed for monochrome or color versions. The active area is surrounded with optically transparent dummy pixels to improve image uniformity within the active area. Not all dummy pixels or barrier pixels can be read out.

Figure 2: Pixel Array Description

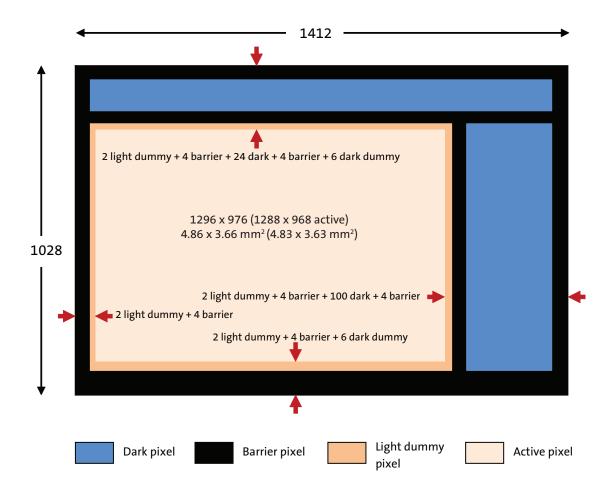
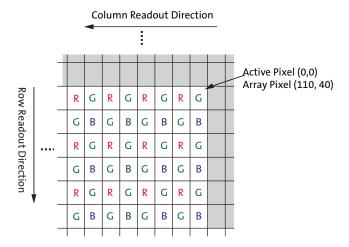




Figure 3: Pixel Color Pattern Detail (Top Right Corner)



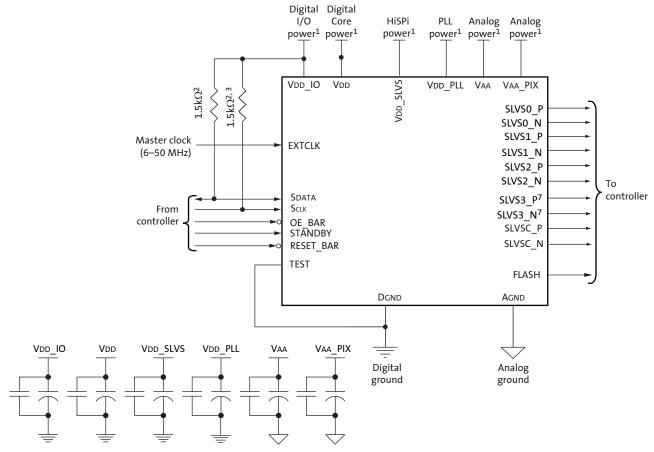
Default Readout Order

By convention, the sensor core pixel array is shown with the first addressable (logical) pixel (0,0) in the top right corner (see Figure 3). This reflects the actual layout of the array on the die. Also, the physical location of the first pixel data read out of the sensor in default condition is that of pixel (112, 44).

Configuration and Pinout

The figures and tables below show a typical configuration for the AR0134 image sensor and show the package pinouts.

Figure 4: Typical Configuration: Serial Four-Lane HiSPi Interface

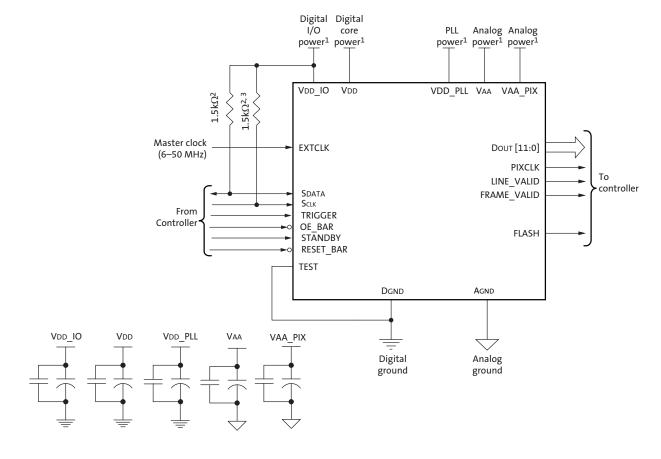


Notes:

- 1. All power supplies must be adequately decoupled.
- 2. ON Semiconductor recommends a resistor value of 1.5k Ω , but it may be greater for slower two-wire speed.
- 3. This pull-up resistor is not required if the controller drives a valid logic level on SCLK at all times.
- 4. The parallel interface output pads can be left unconnected if the serial output interface is used.
- 5. ON Semiconductor recommends that 0.1μF and 10μF decoupling capacitors for each power supply are mounted as close as possible to the pad. Actual values and results may vary depending on layout and design considerations. Refer to the AR0134 demo headboard schematics for circuit recommendations.
- 6. ON Semiconductor recommends that analog power planes be placed in a manner such that coupling with the digital power planes is minimized.
- 7. Although 4 serial lanes are shown, the AR0134 supports only 2 or 3 lane HiSPi.



Figure 5: Typical Configuration: Parallel Pixel Data Interface

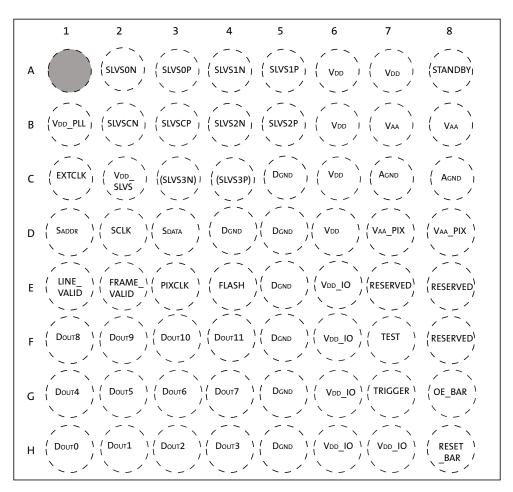


Notes: 1.

- 1. All power supplies must be adequately decoupled.
- 2. ON Semiconductor recommends a resistor value of 1.5k Ω , but it may be greater for slower two-wire speed.
- 3. This pull-up resistor is not required if the controller drives a valid logic level on SCLK at all times.
- 4. The serial interface output pads can be left unconnected if the parallel output interface is used.
- 5. ON Semiconductor recommends that 0.1μF and 10μF decoupling capacitors for each power supply are mounted as close as possible to the pad. Actual values and results may vary depending on layout and design considerations. Refer to the AR0134 demo headboard schematics for circuit recommendations.
- 6. ON Semiconductor recommends that analog power planes be placed in a manner such that coupling with the digital power planes is minimized.



Figure 6: 9x9mm 63-Ball iBGA Package



Top View (Ball Down)



Table 3: Pin Descriptions - 63-Ball iBGA Package

SIVSO_N SIVSO_P A3 Output HiSPi serial data, lane 0, differential N. SIVSI_N A4 Output HiSPi serial data, lane 1, differential P. SIVSI_P A5 Output HiSPi serial data, lane 1, differential P. SIVSI_P A5 Output HiSPi serial data, lane 1, differential P. STANDBY A8 Input Standby-mode enable pin (active HIGH). VPOD_PLL B1 Power PLL power. SIVSC_N B2 Output HiSPi serial DDR clock differential P. SIVSC_N B3 Output HiSPi serial DDR clock differential P. SIVSC_P B3 Output HiSPi serial DDR clock differential P. SIVSC_P B4 Output HiSPi serial DDR clock differential P. SIVSC_P B5 Output HiSPi serial data, lane 2, differential P. SIVSC_P B6 Output HiSPi serial data, lane 2, differential P. A1 A1 A2 A2 A3 A3 B4 A3 A4 B7, B8 Power A3 A1 B7, B8 Power A4 B7, B8 Power A4 A1 A1 B7 B8 Power A4 B7, B8 Power A4 B7, B8 Power A4 B7, B8 Power A5 B0	Name	iBGA Pin	Туре	Description
SLVS1_N SLVS1_P A5 Output HiSPi serial data, lane 1, differential N. SLVS1_P A5 Output HiSPi serial data, lane 1, differential P. STANDBY A8 Input STANDBY A8 Input SLVSC_N B1 Power PLL power. SLVSC_N B2 Output HiSPi serial DDR clock differential P. SLVSC_N B3 Output HiSPi serial DDR clock differential P. SLVS2_P B3 Output HiSPi serial DDR clock differential P. SLVS2_P B5 Output HiSPi serial data, lane 2, differential P. SLVS2_P B5 Output HiSPi serial data, lane 2, differential P. SLVS2_P B5 Output HiSPi serial data, lane 2, differential P. SLVS2_P B5 Output HiSPi serial data, lane 2, differential P. SLVS2_P B5 Output HiSPi serial data, lane 2, differential P. SLVS2_P SLVS3_N C1 Input External input clock. C1 Input External input clock. SLVS3_N C3 Output (Unsupported) HiSPi serial data, lane 3, differential N. SLVS3_N C4 Output (Unsupported) HiSPi serial data, lane 3, differential P. Dono C5, DA, D5, E5, E5, C5, H5 Power Digital GND. SLVS3_P C4 Output (Unsupported) HiSPi serial data, lane 3, differential P. Dono C5, DA, D5, E5, E5, C5, H5 Power Digital GND. SLVS3_P ACND C7, C8 Power Analog GND. SADOR D1 Input Two-Wire Serial address select. SCLX D2 Input Two-Wire Serial data (SL) SOATA D3 I/O Two-Wire Serial	SLVS0_N	A2	Output	HiSPi serial data, lane 0, differential N.
SIVS1_P STANDBY A8 Input Standby-mode enable pin (active HIGH). POD_PLL B1 Power PLL power. SLYSC_N B2 Output HiSPi serial DDR clock differential N. SLYSC_P B3 Output HiSPi serial DDR clock differential N. SLYSC_N B4 Output HiSPi serial DDR clock differential P. SLYSC_N B4 Output HiSPi serial DDR clock differential P. SLYSC_N B4 Output HiSPi serial data, lane 2, differential P. VAA B7, 8B Power Analog power. EXTCLK C1 Input External input clock. YDD_SLYS C2 Power HiSPi power. (May leave unconnected if parallel interface is used) SLYS3_N C3 Output (Unsupported) HiSPi serial data, lane 3, differential N. SLYS3_P C4 Output (Unsupported) HiSPi serial data, lane 3, differential P. DGNO C5, D4, D5, E5, F5, C5, H5 Power Digital CND. DGNO C5, D4, D5, E5, F5, C5, H5 Power Digital DDN VDD A6, A7, B6, C6, D6 Power Analog OND. SADDR D1 Input Two-Wire Serial address select. SCLK D2 Input Two-Wire Serial address select. SCLK D2 Input Two-Wire Serial address select. SCLK D2 Input Two-Wire Serial address select. INE_VALID E1 Output Asserted when Dour fiame data is valid. PIXCLK E3 Output Pixel power. UNE_VALID E1 Output Asserted when Dour fiame data is valid. PIXCLK E3 Output Pixel power. DOURB F1 Output Parallel pixel data output. DOURB F1 Output Parallel pixel data output. DOUTD F2 Output Parallel pixel data output. DOUTD F3 Output Parallel pixel data output. DOUTD G4 Output Parallel pixel data output. DOUTD G5 Output Parallel pixel data output. Exposure synchronization input. (Connect to DCND). DOUTG G3 Output Parallel pixel data output. Exposure synchronization input. (Connect to DCND) interface is used) DOUTD H1 Output Parallel pixel data output. DOUTD H1 Output Parallel pixel data output. POUTD H1 Output Parallel pixel data output. POUTD H1 Output Parallel pixel data output. PARALLE DOUTD H1 Output Parallel pixel data output. PARALLE DOUTD H1 Output Parallel pixel data output. PARALLE DOUTD H1 Output Parallel pixel data output. POUTD H1 Output Parallel pixel data output. PARALLE DO	SLVS0_P	A3	Output	HiSPi serial data, lane 0, differential P.
STANDBY A8 Input Standby-mode enable pin (active HIGH). VDD_PLL B1 Power PLL power. SLYSC_N B2 Output HiSPi serial DDR clock differential N. SLYSC_P B3 Output HiSPi serial DDR clock differential P. SLYSZ_N B4 Output HiSPi serial data, lane 2, differential P. SLYSZ_P B5 Output HiSPi serial data, lane 2, differential P. VAA B7, B8 Power Analog power. EXTCLK C1 Input External input clock. VOD_SLYS C2 Power HiSPi power. (May leave unconnected if parallel interface is used) SLYS3_P C3 Output (Unsupported) HiSPi serial data, lane 3, differential N. SLYS3_P C4 Output (Unsupported) HiSPi serial data, lane 3, differential P. DGND C5, D4, D5, E5, F5, C5, H5 Power Digital CND. VDD A6, A7, B6, C6, D6 Power Digital CND. SADDR D1 Input Two-Wire Serial address select. SCIK D2 Input Two-Wire Serial data (JO. VAA_PIX D3 I/O VAA_PIX D7, D8 Power Pixel power. ASSERTED ASSE	SLVS1_N	A4	Output	HiSPi serial data, lane 1, differential N.
VDD_PLL B1	SLVS1_P	A5	Output	HiSPi serial data, lane 1, differential P.
SLYSC_N SLYSC_P B3 Output HiSPi serial DDR clock differential N. SLYSC_P B3 Output HiSPi serial DDR clock differential N. SLYSC_N B4 Output HiSPi serial DDR clock differential N. SLYSC_P B5 Output HiSPi serial data, Iane 2, differential P. VAA B7, B8 Power Analog power. EXTCLK C1 Input External input clock. VDD_SLYS C2 Power HiSPi power. (May leave unconnected if parallel interface is used) SLYS3_N C3 Output (Unsupported) HiSPi serial data, Iane 3, differential N. SLYS3_P C4 Output (Unsupported) HiSPi serial data, Iane 3, differential N. SLYS3_P C4 Output (Unsupported) HiSPi serial data, Iane 3, differential P. DOND C5, D4, D5, E5, F5, G5, H5 Power Digital GND. DOND A6, A7, B6, C6, D6 Power Digital GND. AGND C7, C8 Power Analog GND. AGND C7, C8 Power Analog GND. SADDR D1 Input Two-Wire Serial dock input. SDATA D3 I/O Two-Wire Serial data I/O. VAA_PIX D7, D8 Power Pixel power. LINE_VALID E1 Output Asserted when Dour line data is valid. FRAME_VALID E2 Output Asserted when Dour fineme data is valid. FRAME_VALID E2 Output Asserted when Dour fineme data is valid. FIXCLK E3 Output Pixel clock out. Dour is valid on rising edge of this clock. LINE_VALID E4 Output Parallel pixel data output. DOUT9 F2 Output Parallel pixel data output. DOUT1 F4 Output Parallel pixel data output. DOUT1 F4 Output Parallel pixel data output. DOUT3 G2 Output Parallel pixel data output. DOUT4 G4 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. DOUT9 G4 Output Parallel pixel data output. DOUT9 G4 Output Parallel pixel data output. EXPOSURE PARALLE	STANDBY	A8	Input	Standby-mode enable pin (active HIGH).
SLVSC_P B3 Output HiSPi serial DDR clock differential P. SLVS2_N B4 Output HiSPi serial data, lane 2, differential N. SLVS2_P B5 Output HiSPi serial data, lane 2, differential N. VAA B7, B8 Power Analog power. EXTCLK C1 Input External input clock. VDD_SLVS C2 Power HiSPi power. (May leave unconnected if parallel interface is used) SLVS3_N C3 Output (Unsupported) HiSPi serial data, lane 3, differential N. SLVS3_P C4 Output (Unsupported) HiSPi serial data, lane 3, differential P. DGND C5, D4, D5, E5, F5, G5, H5 Power Digital GND. VDD A6, A7, B6, C6, D6 Power Digital power. AGND C7, C8 Power Analog GND. SADDR D1 Input Two-Wire Serial address select. SCLK D2 Input Two-Wire Serial address select. SCLK D2 Input Two-Wire Serial data I/O. VAA_PIX D7, D8 Power Pixel power. LINE_VALID E1 Output Asserted when Dour line data is valid. FRAME_VALID E2 Output Asserted when Dour frame data is valid. PIXCLK E3 Output Pixel clock out. Dour is valid on rising edge of this clock. FLASH E4 Output Pixel clock out. Dour is valid on rising edge of this clock. FLASH E4 Output Parallel pixel data output. DOUTB F2 Output Parallel pixel data output. DOUTB G3 Output Parallel pixel data output. DOUTB G3 Output Parallel pixel data output. DOUTB G4 Output Parallel pixel data output. DOUTB G5 Output Parallel pixel data output. DOUTB G7 Output Parallel pixel data output. DOUTB H1 Output Parallel pixel data output. D	VDD_PLL	B1	Power	PLL power.
SIV52_N B4 Output HiSPi serial data, lane 2, differential N. SIV52_P B5 Output HiSPi serial data, lane 2, differential P. VAA B7, B8 Power Analog power. EXTCLK C1 Input External input clock. VDD_SIV5 C2 Power HiSPi power. (May leave unconnected if parallel interface is used) SIV53_N C3 Output (Unsupported) HiSPi serial data, lane 3, differential N. SIV53_P C4 Output (Unsupported) HiSPi serial data, lane 3, differential P. DGND C5, D4, D5, E5, F5, G5, H5 Power Digital CND. VDD A6, A7, B6, C6, D6 Power Digital CND. VDD A6, A7, B6, C6, D6 Power Digital power. ACND C7, C8 Power Analog GND. SADDR D1 Input Two-Wire Serial address select. SCIK D2 Input Two-Wire Serial address select. SCIK D2 Input Two-Wire Serial address select. SOADR D1 VOD Two-Wire Serial address select. SOADR D1 Input Asserted when Dour line data is valid. FRAME_VALID E1 Output Asserted when Dour frame data is valid. FRAME_VALID E2 Output Asserted when Dour frame data is valid. FRAME_VALID E3 Output Pixel clock out. Dour is valid on rising edge of this clock. Control signal to drive external light sources. VOD_IO E6, F6, G6, H6, H7 Power VOD Supply power. DOUT8 F1 Output Parallel pixel data output. DOUT9 DOUT10 F3 Output Parallel pixel data output. DOUT10 DOUT3 G4 Output Parallel pixel data output. Exposure synchronization input. (Connect to DGND). DOUT6 G3 Output Parallel pixel data output. Exposure synchronization input. (Connect to DGND). DOUT6 GA Output Parallel pixel data output. Exposure synchronization input. (Connect to DGND) if HiSPi interface is used) DOUT10 H1 Output Parallel pixel data output. Exposure synchronization input. (Connect to DGND if HiSPi interface is used)	SLVSC_N	B2	Output	HiSPi serial DDR clock differential N.
SLVS2_P WAA B7, B8 Power Analog power. EXTCLK C1 Input External input clock. VDD_SLVS C2 Power HiSPi power. (May leave unconnected if parallel interface is used) SLVS3_N C3 Output (Unsupported) HiSPi serial data, lane 3, differential N. SLVS3_P C4 Output (Unsupported) HiSPi serial data, lane 3, differential N. SLVS3_P C4 Output (Unsupported) HiSPi serial data, lane 3, differential N. SLVS3_P C5, D4, D5, E5, F5, G5, H5 Power Digital GND. A6, A7, B6, C6, D6 Power Analog gND. A6, A7, B6, C6, D6 Power Analog sND. A6, A7, B6, C6, D6 Power Digital GND. A6, A7, B6, C6, D6 Power Analog sND. A6, A7, B6, C6, D6 Power Analog sND. A6, A7, B6, C6, D6 Power Digital GND. A6, A7, B6, C6, D6 Power Analog sND. A6, A7, B6, C6, D6 Power Analog sND. A6, A7, B6, C6, D6 Power Analog sND. A6, A7, B6, C6, D6 Power Digital GND. A6, A7, B6, C6, D6 Power Analog sND. Analog snd snd, ane 3, differential N. Analog snd, ane 3, differential N. Bispical data, lane 3, differential N. Bispical data, lane 3, differential N. Bispical data output. Analog snd, ane 3, differential N. Analog snd, ane 3, differential P. Doural H2 Output Parallel pixel data output. Analog snd, ane 3, differential P. Doural H2 Output Parallel pixel data output. Doural H2 Output Parallel pixel data output. Doural H2 Output Parallel pixel data output. Parallel pixel data output. Parallel pixel data output.	SLVSC_P	В3	Output	HiSPi serial DDR clock differential P.
NAA B7, B8 Power Analog power. EXTCLK C1 Input External input clock. VDD_SLVS C2 Power HiSPi power. (May leave unconnected if parallel interface is used) SLVS3_N C3 Output (Unsupported) HiSPi serial data, lane 3, differential N. SLVS3_P C4 Output (Unsupported) HiSPi serial data, lane 3, differential P. DGND C5, D4, D5, E5, F5, G5, H5 Power Digital GND. VDD A6, A7, B6, C6, D6 Power Digital GND. AGND C7, C8 Power Analog GND. SADDR D1 Input Two-Wire Serial address select. SCIK D2 Input Two-Wire Serial address select. SCIK D2 Input Two-Wire Serial data I/O. VAA_PIX D7, D8 Power Pixel power. LINE_VALID E1 Output Asserted when DOUT line data is valid. FRAME_VALID E2 Output Asserted when DOUT frame data is valid. FIASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. DOUTB F1 Output Parallel pixel data output. DOUTD F3 Output Parallel pixel data output. DOUT1 F4 Output Parallel pixel data output. DOUT1 F4 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. DOUT9 F3 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. DOUT8 G7 Output Parallel pixel data output. DOUT9 F3 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. DOUT9 Parallel pixel data output. Exposure synchronization input. (Connect to DGND if HiSPi interface is used) DOUT0 H1 Output Parallel pixel data output. PARALL P	SLVS2_N	B4	Output	HiSPi serial data, lane 2, differential N.
EXTCLK VDD_SLVS C2 Power HiSPi power, (May leave unconnected if parallel interface is used) Output (Unsupported) HiSPi serial data, lane 3, differential N. SLVS3_P C4 Output Output OUTPUT DOND C5, D4, D5, E5, F5, G5, H5 Power Digital GND. VDD A6, A7, B6, C6, D6 Power Digital GND. C7, C8 Power AGND C7, C8 Power AGND C7, C8 Power AGND SDATA D3 I/O Two-Wire Serial address select. SLINE_VALID E1 Output Asserted when Dour line data is valid. FRAME_VALID FLASH E4 Output Asserted when Dour frame data is valid. FIASH E4 Output Dour18 F1 Output Dour10 F3 Output Parallel pixel data output. Dour11 F4 Output Parallel pixel data output. Dour15 G2 Output Parallel pixel data output. Dour16 G3 Output Parallel pixel data output. Dour17 G4 Output Parallel pixel data output. Dour19 F3 Output Parallel pixel data output. Dour10 F3 Output Parallel pixel data output. Dour15 G2 Output Parallel pixel data output. Dour16 G3 Output Parallel pixel data output. Dour17 G4 Output Parallel pixel data output. Dour19 Parallel pixel data output. Dour10 F3 Output Parallel pixel data output. Dour11 F4 Output Parallel pixel data output. Dour15 G2 Output Parallel pixel data output. Dour16 G3 Output Parallel pixel data output. Dour17 G4 Output Parallel pixel data output. Dour19 F3 Output Parallel pixel data output. Dour19 F4 F7 Input Manufacturing test enable pin (connect to DGND). Dour16 G3 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) DOUT0 H1 Output Parallel pixel data output. Exposure synchronization input. (Connect to DGND if HiSPi interface is used) Output Parallel pixel data output. Parallel pixel data output. Exposure synchronization input. (Connect to DGND if HiSPi interface is used) Output Parallel pixel data output. Parallel pixel data output. Parallel pixel data output. Parallel pixel data output. Parallel pixel data out	SLVS2_P	B5	Output	HiSPi serial data, lane 2, differential P.
VDD_SLVS C2	VAA	B7, B8	Power	Analog power.
SLYS3_N SLYS3_P C4 Output (Unsupported) HiSPi serial data, lane 3, differential N. SLYS3_P C5, D4, D5, E5, F5, G5, H5 Power VDD A6, A7, B6, C6, D6 ACND C7, C8 Power Analog GND. SADDR D1 Input Two-Wire Serial address select. SCLK D2 Input Two-Wire Serial clack input. SDATA D3 I/O VAA_PIX D7, D8 Power LINE_VALID E1 Output Asserted when Dou⊤ line data is valid. PIXCLK E3 Output Pixel clock out. Dou⊤ is valid on rising edge of this clock. FRAME_VALID FRAME_VALID D0u79 F2 Output Parallel pixel data output. DouT1 F4 Output Parallel pixel data output. DouT4 G1 Output Parallel pixel data output. DouT5 G2 Output Parallel pixel data output. DouT6 G3 Output Parallel pixel data output. DouT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output Parallel pixel data output. DOUT0 H1 Output Parallel pixel data output. Paral	EXTCLK	C1	Input	External input clock.
SLV53_P C4 Output (Unsupported) HiSPi serial data, lane 3, differential P. DGND C5, D4, D5, E5, F5, G5, H5 Power Digital GND. VDD A6, A7, B6, C6, D6 Power Analog GND. AGND C7, C8 Power Analog GND. SADDR D1 Input Two-Wire Serial address select. SCLK D2 Input Two-Wire Serial address select. SCLK D2 Input Two-Wire Serial address select. SDATA D3 I/O Two-Wire Serial data I/O. VAA_PIX D7, D8 Power Pixel power. LINE_VALID E1 Output Asserted when Dout I fine data is valid. FRAME_VALID E2 Output Asserted when Dout frame data is valid. PIXCLK E3 Output Pixel clock out. Dout is valid on rising edge of this clock. FLASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. DOUT8 F1 Output Parallel pixel data output. DOUT9 F2 Output Parallel pixel data output. DOUT10 F3 Output Parallel pixel data output. DOUT11 F4 Output Parallel pixel data output. DOUT11 F4 Output Parallel pixel data output. DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. DOUT9 F2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. DOUT0 G3 Output Parallel pixel data output. DOUT0 G4 G3 Output Parallel pixel data output. DOUT0 G4 Output Parallel pixel data output. DOUT0 G5 G2 Output Parallel pixel data output. DOUT0 G4 G3 Output Parallel pixel data output. DOUT0 G4 G3 Output Parallel pixel data output. DOUT0 G4 G8 Input Connect to DGND if HiSPi interface is used) DOUT0 H1 Output Parallel pixel data output. DOUT0 H2 Output Parallel pixel data output. POUT0 H2 Output Parallel pixel data output. POUT0 H2 Output Parallel pixel data output. POUT0 H1 Output Parallel pixel data output. POUT0 Par	VDD_SLVS	C2	Power	HiSPi power. (May leave unconnected if parallel interface is used)
Dond C5, D4, D5, E5, F5, G5, H5 Power Digital GND. VDD A6, A7, B6, C6, D6 Power Digital power. ACND C7, C8 Power Analog GND. SADDR D1 Input Two-Wire Serial address select. SCLK D2 Input Two-Wire Serial data I/O. VAA_PIX D7, D8 Power Pixel power. LINE_VALID E1 Output Asserted when Dou't line data is valid. FRAME_VALID E2 Output Pixel clock out. Dou't is valid on rising edge of this clock. FLASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. DOUTB F1 Output Parallel pixel data output. DOUT1 F3 Output Parallel pixel data output. DOUT1 F4 Output Parallel pixel data output. DOUT1 F5 G2 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G8 Input Output exposure synchronization input. (Connect to DGND if HiSPi interface is used) DOUT0 H1 Output Parallel pixel data output. POUT1 H2 Output Parallel pixel data output. DOUT1 H2 Output Parallel pixel data output. DOUT1 G4 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. DOUT9 G4 Output Parallel pixel data output. DOUT0 H1 Output Parallel pixel data output. DOUT0 H1 Output Parallel pixel data output. DOUT0 H1 Output Parallel pixel data output. POUT1 H2 Output Parallel pixel data output. POUT2 Parallel pixel data output. POUT2 Parallel pixel data output. POUT1 Parallel pixel data output. POUT2 Parallel pixel data output.	SLVS3_N	C3	Output	(Unsupported) HiSPi serial data, lane 3, differential N.
VDD	SLVS3_P	C4	Output	(Unsupported) HiSPi serial data, lane 3, differential P.
AGND C7, C8 Power Analog GND. SADDR D1 Input Two-Wire Serial address select. SCLK D2 Input Two-Wire Serial clock input. SDATA D3 I/O Two-Wire Serial clock input. SDATA D3 I/O Two-Wire Serial data I/O. VAA_PIX D7, D8 Power Pixel power. LINE_VALID E1 Output Asserted when Dour line data is valid. PIXCLK E3 Output Pixel clock out. Dour is valid on rising edge of this clock. FLASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. Dour18 F1 Output Parallel pixel data output. Dour10 F3 Output Parallel pixel data output. Dour11 F4 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DGND). Dour15 G2 Output Parallel pixel data output. Dour16 G3 Output Parallel pixel data output. Dour17 G4 Output Parallel pixel data output. Dour18 Dour19 G3 Output Parallel pixel data output. Dour19 Dour19 G2 Output Parallel pixel data output. Dour19 Dour19 G3 Output Parallel pixel data output. Dour19 Dour19 G3 Output Parallel pixel data output. Dour19 Dour19 G4 Output Parallel pixel data output. Dour19 Dour19 G3 Output Parallel pixel data output. Dour19 Dour19 G4 Output Parallel pixel data output. Dour10 F3 Output Parallel pixel data output. Dour11 F4 Output Parallel pixel data output. Dour2 H1 Output Parallel pixel data output. Parallel pixel data output. Exposure synchronization input. (Connect to DGND if HiSPi interface is used) Output Parallel pixel data output. Pa	DGND	C5, D4, D5, E5, F5, G5, H5	Power	Digital GND.
SADDR D1 Input Two-Wire Serial address select. SCLK D2 Input Two-Wire Serial clock input. SDATA D3 I/O Two-Wire Serial clock input. SDATA D7, D8 Power Pixel power. LINE_VALID E1 Output Asserted when Dou'r line data is valid. FRAME_VALID E2 Output Asserted when Dou'r frame data is valid. PIXCLK E3 Output Pixel clock out. Dour is valid on rising edge of this clock. FLASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. DOUTB F1 Output Parallel pixel data output. DOUT10 F3 Output Parallel pixel data output. DOUT11 F4 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DCND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DCND if HiSPi interface is used) OE_BAR G8 Input Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output. POUT1 Parallel pixel data output. POUT2 H3 Output Parallel pixel data output. POUT1 H2 Output Parallel pixel data output. POUT1 Parallel pixel data output. POUT1 Parallel pixel data output. POUT1 Parallel pixel data output. POUT2 Parallel pixel data output. POUT2 Parallel pixel data output. (LSB)	VDD	A6, A7, B6, C6, D6	Power	Digital power.
SCIK D2 Input Two-Wire Serial clock input. SDATA D3 I/O Two-Wire Serial data I/O. VAA_PIX D7, D8 Power Pixel power. LINE_VALID E1 Output Asserted when DouT line data is valid. FRAME_VALID E2 Output Asserted when Dout frame data is valid. PIXCLK E3 Output Pixel clock out. Dour is valid on rising edge of this clock. FLASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. DOUTB F1 Output Parallel pixel data output. DOUT9 F2 Output Parallel pixel data output. DOUT10 F3 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DGND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output. POUT1 Parallel pixel data output. POUT0 H1 Output Parallel pixel data output. POUT0 H2 Output Parallel pixel data output. Parallel pixel data output. PouT7 G4 Output Parallel pixel data output. POUT0 H2 Parallel pixel data output. POUT0 Parallel pixel data output. PARALLE PIXEL	AGND	C7, C8	Power	Analog GND.
SDATA D3 I/O Two-Wire Serial data I/O. VAA_PIX D7, D8 Power Pixel power. LINE_VALID E1 Output Asserted when Dour line data is valid. FRAME_VALID E2 Output Asserted when Dour frame data is valid. PIXCLK E3 Output Pixel clock out. Dour is valid on rising edge of this clock. FLASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. DOUT8 F1 Output Parallel pixel data output. DOUT9 F2 Output Parallel pixel data output. DOUT10 F3 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DGND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) DOUT0 H1 Output Parallel pixel data output. POUT0 H2 Output Parallel pixel data output. DOUT0 H3 Output Parallel pixel data output. POUT0 H4 Output Parallel pixel data output. DOUT0 G4 Output Parallel pixel data output. DOUT1 H2 Output Parallel pixel data output. POUT0 H3 Output Parallel pixel data output. DOUT0 H4 Output Parallel pixel data output. POUT0 H5 Output Parallel pixel data output. DOUT0 H1 Output Parallel pixel data output. POUT0 H4 Output Parallel pixel data output. POUT0 H4 Output Parallel pixel data output. (Connect to DGND if HiSPi interface is used) DOUT0 H4 Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output.	SADDR	D1	Input	Two-Wire Serial address select.
VAA_PIX D7, D8 Power Pixel power. LINE_VALID E1 Output Asserted when DOUT line data is valid. FRAME_VALID E2 Output Asserted when DOUT frame data is valid. PIXCLK E3 Output Pixel clock out. DOUT is valid on rising edge of this clock. FLASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. DOUT8 F1 Output Parallel pixel data output. DOUT9 F2 Output Parallel pixel data output. DOUT10 F3 Output Parallel pixel data output. DOUT11 F4 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DGND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) DOUT0 H1 Output Parallel pixel data output (LSB) DOUT0 H1 Output Parallel pixel data output. Poutput enable (active LOW). DOUT0 H1 Output Parallel pixel data output. Parallel pixel data output. Poutput enable (active LOW). DOUT0 H1 Output Parallel pixel data output.	Sclk	D2	Input	Two-Wire Serial clock input.
LINE_VALID E1 Output Asserted when DOUT line data is valid. FRAME_VALID E2 Output Asserted when DOUT frame data is valid. PIXCLK E3 Output Pixel clock out. DOUT is valid on rising edge of this clock. FLASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. DOUT8 F1 Output Parallel pixel data output. DOUT9 F2 Output Parallel pixel data output. DOUT10 F3 Output Parallel pixel data output. DOUT11 F4 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DGND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output enable (active LOW). DOUT0 H1 Output Parallel pixel data output. Parallel pixel data output. (LSB) DOUT0 H1 Output Parallel pixel data output. Parallel pixel data output. (Parallel pixel data output. Exposure synchronization input. (Connect to DGND if HiSPi interface is used) Parallel pixel data output (LSB) DOUT0 H1 Output Parallel pixel data output. Parallel pixel data output. Parallel pixel data output. Parallel pixel data output.	Sdata	D3	I/O	Two-Wire Serial data I/O.
FRAME_VALID E2 Output Asserted when DouT frame data is valid. PIXCLK E3 Output Pixel clock out. DouT is valid on rising edge of this clock. FLASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. DOUT8 F1 Output Parallel pixel data output. DOUT9 F2 Output Parallel pixel data output. DOUT10 F3 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DGND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output Parallel pixel data output (LSB) DOUT0 H1 Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output. Parallel pixel data output. Parallel pixel data output. Exposure synchronization input. (Connect to DGND if HiSPi interface is used) DOUT0 H1 Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output.	VAA_PIX	D7, D8	Power	Pixel power.
PIXCLK E3 Output Pixel clock out. Dour is valid on rising edge of this clock. FLASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. DOUT8 F1 Output Parallel pixel data output. DOUT9 F2 Output Parallel pixel data output. DOUT10 F3 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DGND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) DOUT0 H1 Output Parallel pixel data output. DOUT0 H1 Output Parallel pixel data output. Exposure synchronization input. (Connect to DGND if HiSPi interface is used) DOUT0 H1 Output Parallel pixel data output. DOUT0 H2 Output Parallel pixel data output. Parallel pixel data output. Exposure synchronization input. (Connect to DGND if HiSPi interface is used) DOUT0 H1 Output Parallel pixel data output. (LSB) DOUT1 H2 Output Parallel pixel data output. Parallel pixel data output. Parallel pixel data output. DOUT1 H2 Output Parallel pixel data output. Parallel pixel data output. Parallel pixel data output. DOUT1 Parallel pixel data output. Parallel pixel data output. Parallel pixel data output. Parallel pixel data output.	LINE_VALID	E1	Output	Asserted when Do∪⊤ line data is valid.
FLASH E4 Output Control signal to drive external light sources. VDD_IO E6, F6, G6, H6, H7 Power I/O supply power. DOUT8 F1 Output Parallel pixel data output. DOUT9 F2 Output Parallel pixel data output. DOUT10 F3 Output Parallel pixel data output. DOUT11 F4 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DGND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output Parallel pixel data output (LSB) DOUT0 H1 Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output. Parallel pixel data output. (Connect to DGND if HiSPi interface is used) DOUT0 H1 Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output.	FRAME_VALID	E2	Output	Asserted when Do∪T frame data is valid.
VDD_IOE6, F6, G6, H6, H7PowerI/O supply power.DOUT8F1OutputParallel pixel data output.DOUT9F2OutputParallel pixel data output.DOUT10F3OutputParallel pixel data output.DOUT11F4OutputParallel pixel data output (MSB)TESTF7InputManufacturing test enable pin (connect to DGND).DOUT4G1OutputParallel pixel data output.DOUT5G2OutputParallel pixel data output.DOUT6G3OutputParallel pixel data output.DOUT7G4OutputParallel pixel data output.TRIGGERG7InputExposure synchronization input. (Connect to DGND if HiSPi interface is used)OE_BARG8InputOutput enable (active LOW).DOUT0H1OutputParallel pixel data output (LSB)DOUT1H2OutputParallel pixel data output.DOUT2H3OutputParallel pixel data output.	PIXCLK	E3	Output	Pixel clock out. Dout is valid on rising edge of this clock.
DOUT8 F1 Output Parallel pixel data output. DOUT9 F2 Output Parallel pixel data output. DOUT10 F3 Output Parallel pixel data output. DOUT11 F4 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DGND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output enable (active LOW). DOUT0 H1 Output Parallel pixel data output. DOUT1 H2 Output Parallel pixel data output. Parallel pixel data output. (LSB) DOUT1 H2 Output Parallel pixel data output.	FLASH	E4	Output	Control signal to drive external light sources.
DOUT9 F2 Output Parallel pixel data output. DOUT10 F3 Output Parallel pixel data output. DOUT11 F4 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DGND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output enable (active LOW). DOUT0 H1 Output Parallel pixel data output. DOUT1 H2 Output Parallel pixel data output. Parallel pixel data output. Parallel pixel data output.	VDD_IO	E6, F6, G6, H6, H7	Power	I/O supply power.
DOUT10 F3 Output Parallel pixel data output. DOUT11 F4 Output Parallel pixel data output (MSB) TEST F7 Input Manufacturing test enable pin (connect to DGND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output enable (active LOW). DOUT0 H1 Output Parallel pixel data output. (LSB) DOUT1 H2 Output Parallel pixel data output.	D оит8	F1	Output	Parallel pixel data output.
DOUT11F4OutputParallel pixel data output (MSB)TESTF7InputManufacturing test enable pin (connect to DGND).DOUT4G1OutputParallel pixel data output.DOUT5G2OutputParallel pixel data output.DOUT6G3OutputParallel pixel data output.DOUT7G4OutputParallel pixel data output.TRIGGERG7InputExposure synchronization input. (Connect to DGND if HiSPi interface is used)OE_BARG8InputOutput enable (active LOW).DOUT0H1OutputParallel pixel data output (LSB)DOUT1H2OutputParallel pixel data output.DOUT2H3OutputParallel pixel data output.	D оит9	F2	Output	Parallel pixel data output.
TEST F7 Input Manufacturing test enable pin (connect to DGND). DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output enable (active LOW). DOUT0 H1 Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output. DOUT2 H3 Output Parallel pixel data output.	Dout10	F3	Output	Parallel pixel data output.
DOUT4 G1 Output Parallel pixel data output. DOUT5 G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output enable (active LOW). DOUT0 H1 Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output. Parallel pixel data output.	Dout11	F4	Output	Parallel pixel data output (MSB)
DOUTS G2 Output Parallel pixel data output. DOUT6 G3 Output Parallel pixel data output. DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output enable (active LOW). DOUT0 H1 Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output. DOUT2 H3 Output Parallel pixel data output.	TEST	F7	Input	Manufacturing test enable pin (connect to DGND).
DOUT6G3OutputParallel pixel data output.DOUT7G4OutputParallel pixel data output.TRIGGERG7InputExposure synchronization input. (Connect to DGND if HiSPi interface is used)OE_BARG8InputOutput enable (active LOW).DOUT0H1OutputParallel pixel data output (LSB)DOUT1H2OutputParallel pixel data output.DOUT2H3OutputParallel pixel data output.	Dout4	G1	Output	Parallel pixel data output.
DOUT7 G4 Output Parallel pixel data output. TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output enable (active LOW). DOUT0 H1 Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output. DOUT2 H3 Output Parallel pixel data output.	D оит5	G2	Output	Parallel pixel data output.
TRIGGER G7 Input Exposure synchronization input. (Connect to DGND if HiSPi interface is used) OE_BAR G8 Input Output enable (active LOW). DOUT0 H1 Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output. DOUT2 H3 Output Parallel pixel data output.	D оит6	G3	Output	Parallel pixel data output.
OE_BAR G8 Input Output enable (active LOW). DOUT0 H1 Output Parallel pixel data output (LSB) DOUT1 H2 Output Parallel pixel data output. DOUT2 H3 Output Parallel pixel data output.	D оит 7	G4	Output	Parallel pixel data output.
DOUTOH1OutputParallel pixel data output (LSB)DOUT1H2OutputParallel pixel data output.DOUT2H3OutputParallel pixel data output.	TRIGGER	G7	Input	
DOUT1 H2 Output Parallel pixel data output. DOUT2 H3 Output Parallel pixel data output.	OE_BAR	G8	Input	Output enable (active LOW).
DOUT2 H3 Output Parallel pixel data output.	Dоит0	H1	Output	Parallel pixel data output (LSB)
·	Dout1	H2	Output	Parallel pixel data output.
DOUT3 H4 Output Parallel pixel data output.	Dоит2	H3	Output	Parallel pixel data output.
	D оит3	H4	Output	Parallel pixel data output.



Table 3: Pin Descriptions (continued)- 63-Ball iBGA Package

Name	iBGA Pin	Туре	Description
RESET_BAR	Н8	Input	Asynchronous reset (active LOW). All settings are restored to factory default.
Reserved	E7, E8, F8	n/a	Reserved (do not connect).

Figure 7: 48 iLCC Package, Parallel Output

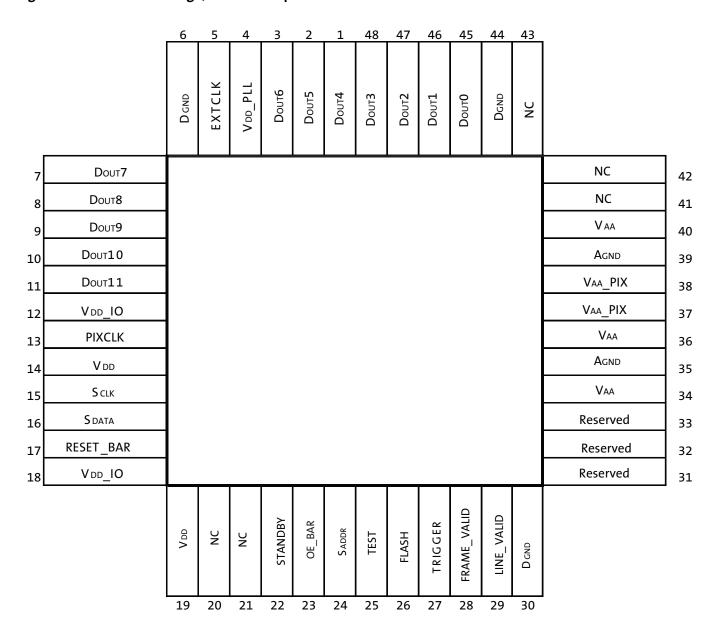




Table 4: Pin Descriptions - 48 iLCC Package, Parallel

Pin Number	Name	Туре	Description
1	Douт4	Output	Parallel pixel data output.
2	Dоит5	Output	Parallel pixel data output.
3	D оит6	Output	Parallel pixel data output.
4	VDD_PLL	Power	PLL power.
5	EXTCLK	Input	External input clock.
6	DGND	Power	Digital ground.
7	D оит 7	Output	Parallel pixel data output.
8	D оит8	Output	Parallel pixel data output.
9	D оит 9	Output	Parallel pixel data output.
10	Dout10	Output	Parallel pixel data output.
11	Dout11	Output	Parallel pixel data output (MSB).
12	VDD_IO	Power	I/O supply power.
13	PIXCLK	Output	Pixel clock out. Dou⊤ is valid on rising edge of this clock.
14	Vdd	Power	Digital power.
15	Sclk	Input	Two-Wire Serial clock input.
16	Sdata	1/0	Two-Wire Serial data I/O.
17	RESET_BAR	Input	Asynchronous reset (active LOW). All settings are restored to factory default.
18	VDD_IO	Power	I/O supply power.
19	Vdd	Power	Digital power.
20	NC		No connection.
21	NC		No connection.
22	STANDBY	Input	Standby-mode enable pin (active HIGH).
23	OE_BAR	Input	Output enable (active LOW).
24	Saddr	Input	Two-Wire Serial address select.
25	TEST	Input	Manufacturing test enable pin (connect to DGND).
26	FLASH	Output	Flash output control.
27	TRIGGER	Input	Exposure synchronization input.
28	FRAME_VALID	Output	Asserted when Dout frame data is valid.
29	LINE_VALID	Output	Asserted when Dout line data is valid.
30	DGND	Power	Digital ground
31	Reserved	n/a	Reserved (do not connect).
32	Reserved	n/a	Reserved (do not connect).
33	Reserved	n/a	Reserved (do not connect).
34	VAA	Power	Analog power.
35	Agnd	Power	Analog ground.
36	VAA	Power	Analog power.
37	VAA_PIX	Power	Pixel power.
38	VAA_PIX	Power	Pixel power.
39	Agnd	Power	Analog ground.
40	VAA	Power	Analog power.
41	NC		No connection.
42	NC		No connection.
43	NC		No connection.





Table 4: Pin Descriptions (continued)- 48 iLCC Package, Parallel

Pin Number	Name	Туре	Description
44	DGND	Power	Digital ground.
45	Dоит 0	Output	Parallel pixel data output (LSB)
46	Dout1	Output	Parallel pixel data output.
47	D оит2	Output	Parallel pixel data output.
48	D оит3	Output	Parallel pixel data output.

Two-Wire Serial Register Interface

The two-wire serial interface bus enables read/write access to control and status registers within the AR0134. The interface protocol uses a master/slave model in which a master controls one or more slave devices. The sensor acts as a slave device. The master generates a clock (SCLK) that is an input to the sensor and is used to synchronize transfers. Data is transferred between the master and the slave on a bidirectional signal (SDATA). SDATA is pulled up to VDD_IO off-chip by a 1.5k Ω resistor. Either the slave or master device can drive SDATA LOW—the interface protocol determines which device is allowed to drive SDATA at any given time.

The protocols described in the two-wire serial interface specification allow the slave device to drive SCLK LOW; the AR0134 uses SCLK as an input only and therefore never drives it LOW.

Protocol

Data transfers on the two-wire serial interface bus are performed by a sequence of low-level protocol elements:

- 1. a (repeated) start condition
- 2. a slave address/data direction byte
- 3. an (a no) acknowledge bit
- 4. a message byte
- 5. a stop condition

The bus is idle when both SCLK and SDATA are HIGH. Control of the bus is initiated with a start condition, and the bus is released with a stop condition. Only the master can generate the start and stop conditions.

Start Condition

A start condition is defined as a HIGH-to-LOW transition on SDATA while Sclk is HIGH. At the end of a transfer, the master can generate a start condition without previously generating a stop condition; this is known as a "repeated start" or "restart" condition.

Stop Condition

A stop condition is defined as a LOW-to-HIGH transition on SDATA while Sclk is HIGH.

Data Transfer

Data is transferred serially, 8 bits at a time, with the MSB transmitted first. Each byte of data is followed by an acknowledge bit or a no-acknowledge bit. This data transfer mechanism is used for the slave address/data direction byte and for message bytes.

One data bit is transferred during each SCLK clock period. SDATA can change when SCLK is LOW and must be stable while SCLK is HIGH.

Slave Address/Data Direction Byte

Bits [7:1] of this byte represent the device slave address and bit [0] indicates the data transfer direction. A "0" in bit [0] indicates a WRITE, and a "1" indicates a READ. The default slave addresses used by the AR0134 are 0x20 (write address) and 0x21 (read address) in accordance with the specification. Alternate slave addresses of 0x30 (write address) and 0x31 (read address) can be selected by enabling and asserting the SADDR input.



An alternate slave address can also be programmed through R0x31FC.

Message Byte

Message bytes are used for sending register addresses and register write data to the slave device and for retrieving register read data.

Acknowledge Bit

Each 8-bit data transfer is followed by an acknowledge bit or a no-acknowledge bit in the Sclk clock period following the data transfer. The transmitter (which is the master when writing, or the slave when reading) releases SDATA. The receiver indicates an acknowledge bit by driving SDATA LOW. As for data transfers, SDATA can change when Sclk is LOW and must be stable while Sclk is HIGH.

No-Acknowledge Bit

The no-acknowledge bit is generated when the receiver does not drive SDATA LOW during the Sclk clock period following a data transfer. A no-acknowledge bit is used to terminate a read sequence.

Typical Sequence

A typical READ or WRITE sequence begins by the master generating a start condition on the bus. After the start condition, the master sends the 8-bit slave address/data direction byte. The last bit indicates whether the request is for a read or a write, where a "0" indicates a write and a "1" indicates a read. If the address matches the address of the slave device, the slave device acknowledges receipt of the address by generating an acknowledge bit on the bus.

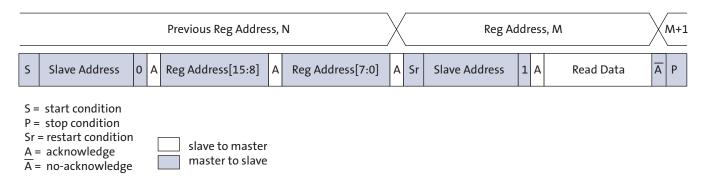
If the request was a WRITE, the master then transfers the 16-bit register address to which the WRITE should take place. This transfer takes place as two 8-bit sequences and the slave sends an acknowledge bit after each sequence to indicate that the byte has been received. The master then transfers the data as an 8-bit sequence; the slave sends an acknowledge bit at the end of the sequence. The master stops writing by generating a (re)start or stop condition.

If the request was a READ, the master sends the 8-bit write slave address/data direction byte and 16-bit register address, the same way as with a WRITE request. The master then generates a (re)start condition and the 8-bit read slave address/data direction byte, and clocks out the register data, eight bits at a time. The master generates an acknowledge bit after each 8-bit transfer. The slave's internal register address is automatically incremented after every 8 bits are transferred. The data transfer is stopped when the master sends a no-acknowledge bit.

Single READ from Random Location

This sequence (Figure 8 on page 17) starts with a dummy WRITE to the 16-bit address that is to be used for the READ. The master terminates the WRITE by generating a restart condition. The master then sends the 8-bit read slave address/data direction byte and clocks out one byte of register data. The master terminates the READ by generating a no-acknowledge bit followed by a stop condition. Figure 8 shows how the internal register address maintained by the AR0134 is loaded and incremented as the sequence proceeds.

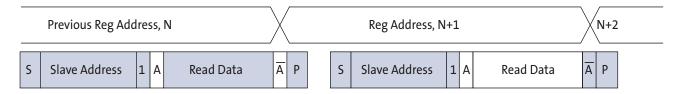
Figure 8: Single READ from Random Location



Single READ from Current Location

This sequence (Figure 9) performs a read using the current value of the AR0134 internal register address. The master terminates the READ by generating a no-acknowledge bit followed by a stop condition. The figure shows two independent READ sequences.

Figure 9: Single READ from Current Location

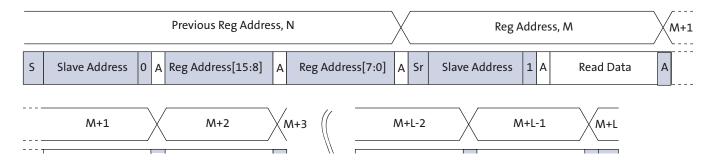




Sequential READ, Start from Random Location

This sequence (Figure 10) starts in the same way as the single READ from random location (Figure 8). Instead of generating a no-acknowledge bit after the first byte of data has been transferred, the master generates an acknowledge bit and continues to perform byte READs until "L" bytes have been read.

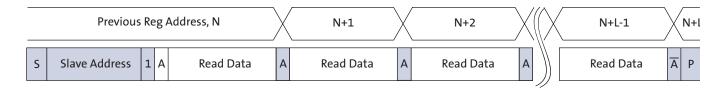
Figure 10: Sequential READ, Start from Random Location



Sequential READ, Start from Current Location

This sequence (Figure 11) starts in the same way as the single READ from current location (Figure 9 on page 17). Instead of generating a no-acknowledge bit after the first byte of data has been transferred, the master generates an acknowledge bit and continues to perform byte READs until "L" bytes have been read.

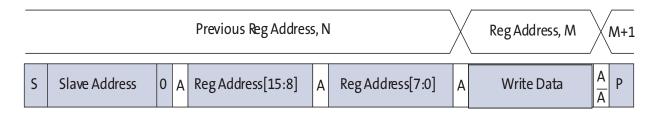
Figure 11: Sequential READ, Start from Current Location



Single WRITE to Random Location

This sequence (Figure 12) begins with the master generating a start condition. The slave address/data direction byte signals a WRITE and is followed by the HIGH then LOW bytes of the register address that is to be written. The master follows this with the byte of write data. The WRITE is terminated by the master generating a stop condition.

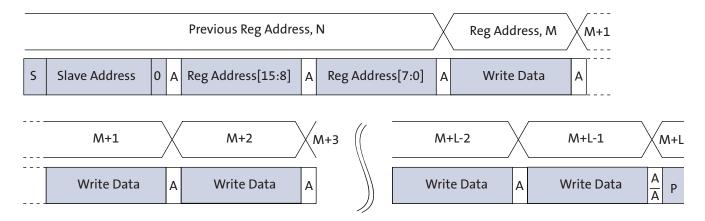
Figure 12: Single WRITE to Random Location



Sequential WRITE, Start at Random Location

This sequence (Figure 13) starts in the same way as the single WRITE to random location (Figure 12). Instead of generating a no-acknowledge bit after the first byte of data has been transferred, the master generates an acknowledge bit and continues to perform byte WRITEs until "L" bytes have been written. The WRITE is terminated by the master generating a stop condition.

Figure 13: Sequential WRITE, Start at Random Location





Electrical Specifications

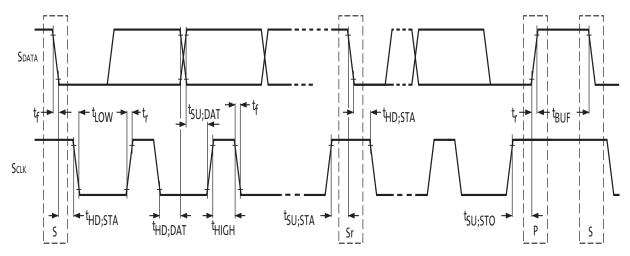
Unless otherwise stated, the following specifications apply to the following conditions:

 $\label{eq:VDD} VDD = 1.8V - 0.10/+0.15; VDD_IO = VDD_PLL = VAA = VAA_PIX = 2.8V \pm 0.3V; \\ VDD_SLVS = 0.4V - 0.1/+0.2; \\ T_A = -30^{\circ}C \ to \ +70^{\circ}C; \ output \ load = 10pF; \\ PIXCLK \ frequency = 74.25 \ MHz; \ HiSPi \ off. \\ \\$

Two-Wire Serial Register Interface

The electrical characteristics of the two-wire serial register interface (SCLK, SDATA) are shown in Figure 14 and Table 5.

Figure 14: Two-Wire Serial Bus Timing Parameters



Note: Read sequence: For an 8-bit READ, read waveforms start after WRITE command and register address are issued.

Table 5: Two-Wire Serial Bus Characteristics

 $^{\rm f}$ EXTCLK = 27 MHz; VDD = 1.8V; VDD_IO = 2.8V; VAA = 2.8V; VAA_PIX = 2.8V; VDD_PLL = 2.8V; VDD_DAC = 2.8V; $^{\rm f}$ TA = 25°C

		Standard-Mode		Fast-		
Parameter	Symbol	Min	Max	Min	Max	Unit
SCLK Clock Frequency	^f SCL	0	100	0	400	KHz
Hold time (repeated) START condition.						
After this period, the first clock pulse is generated	^t HD;STA	4.0	-	0.6	-	μS
LOW period of the SCLK clock	^t LOW	4.7	-	1.3	-	μS
HIGH period of the SCLK clock	^t HIGH	4.0	-	0.6	-	μS
Set-up time for a repeated START condition	^t SU;STA	4.7	-	0.6	-	μS
Data hold time:	^t HD;DAT	04	3.45 ⁵	0 ⁶	0.9 ⁵	μS
Data set-up time	^t SU;DAT	250	-	100 ⁶	-	nS
Rise time of both SDATA and SCLK signals	^t r	-	1000	20 + 0.1Cb ⁷	300	nS
Fall time of both SDATA and SCLK signals	^t f	-	300	20 + 0.1Cb ⁷	300	nS





Table 5: Two-Wire Serial Bus Characteristics

 $^{\rm f}$ EXTCLK = 27 MHz; VDD = 1.8V; VDD_IO = 2.8V; VAA = 2.8V; VAA_PIX = 2.8V; VDD_PLL = 2.8V; VDD_DAC = 2.8V; $^{\rm T}$ A = 25°C

		Standard-Mode		Fast-		
Parameter	Symbol	Min	Max	Min	Max	Unit
Set-up time for STOP condition	^t SU;STO	4.0	-	0.6	-	μS
Bus free time between a STOP and START condition	^t BUF	4.7	-	1.3	-	μS
Capacitive load for each bus line	Cb	-	400	-	400	pF
Serial interface input pin capacitance	CIN_SI	-	3.3	-	3.3	pF
SDATA max load capacitance	CLOAD_SD	-	30	-	30	pF
SDATA pull-up resistor	RSD	1.5	4.7	1.5	4.7	ΚΩ

Notes:

- 1. This table is based on I²C standard (v2.1 January 2000). Philips Semiconductor.
- 2. Two-wire control is I²C-compatible.
- 3. All values referred to V_{IHmin} = 0.9 VDD and V_{ILmax} = 0.1 VDD levels. Sensor EXCLK = 27 MHz.
- 4. A device must internally provide a hold time of at least 300 ns for the SDATA signal to bridge the undefined region of the falling edge of SCLK.
- 5. The maximum ^tHD;DAT has only to be met if the device does not stretch the LOW period (^tLOW) of the SCLK signal.
- 6. A Fast-mode I²C-bus device can be used in a Standard-mode I²C-bus system, but the requirement [†]SU;DAT 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCLK signal. If such a device does stretch the LOW period of the SCLK signal, it must output the next data bit to the SDATA line [†]r max + [†]SU;DAT = 1000 + 250 = 1250 ns (according to the Standard-mode I²C-bus specification) before the SCLK line is released.
- 7. Cb = total capacitance of one bus line in pF.



I/O Timing

By default, the AR0134 launches pixel data, FV and LV with the falling edge of PIXCLK. The expectation is that the user captures DOUT[11:0], FV and LV using the rising edge of PIXCLK. The launch edge of PIXCLK can be configured in register R0x3028. See Figure 15 and Table 6 for I/O timing (AC) characteristics.

Figure 15: I/O Timing Diagram

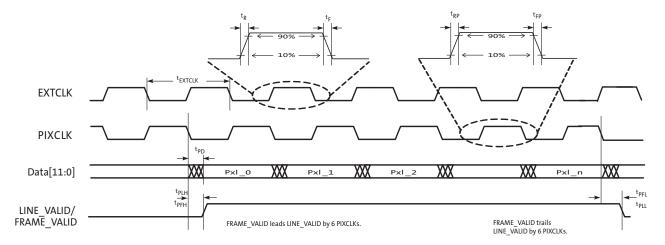


Table 6: I/O Timing Characteristics, Parallel Output (1.8V VDD_IO)¹

Symbol	Definition	Condition	Min	Тур	Max	Unit
f _{EXTCLK}	Input clock frequency		6		50	MHz
t _{EXTCLK}	Input clock period		20		166	ns
t _R	Input clock rise time	PLL enabled		3		ns
t _F	Input clock fall time	PLL enabled		3		ns
t _{jJITTER}	Input clock jitter				600	ns
t _{cp}	EXTCLK to PIXCLK propagation delay	Nominal voltages, PLL disabled, PIXCLK slew rate = 4	5.7		14.3	ns
t _{RP}	PIXCLK rise time	PCLK slew rate = 6	1.3		4.0	ns
t _{FP}	PIXCLK fall time	PCLK slew rate = 6	1.3		3.9	ns
	PIXCLK duty cycle		40	50	60	%
f _{PIXCLK}	PIXCLK frequency	PIXCLK slew rate = 6, Data slew rate = 7	6		74.25	MHz
t _{PD}	PIXCLK to data valid	PIXCLK slew rate = 6, Data slew rate = 7	-2.5		2	ns
t _{PFH}	PIXCLK to FV HIGH	PIXCLK slew rate = 6, Data slew rate = 7	-2.5		2	ns
t _{PLH}	PIXCLK to LV HIGH	PIXCLK slew rate = 6, Data slew rate = 7	-3		1.5	ns
t _{PFL}	PIXCLK to FV LOW	PIXCLK slew rate = 6, Data slew rate = 7	-2.5		2	ns
t _{PLL}	PIXCLK to LV LOW	PIXCLK slew rate = 6, Data slew rate = 7	-3		1.5	ns
CIN	Input pin capacitance			2.5		pf



Notes:

- 1. Minimum and maximum values are taken at 70°C, 1.7V and -30°C, 1.95V. All values are taken at the 50% transition point. The loading used is 10 pF.
- 2. Jitter from PIXCLK is already taken into account in the data for all of the output parameters.

Table 7: I/O Timing Characteristics, Parallel Output (2.8V VDD_IO)¹

Symbol	Definition	Condition	Min	Тур	Max	Unit
f _{EXTCLK}	Input clock frequency		6		50	MHz
t _{EXTCLK}	Input clock period		20		166	ns
t _R	Input clock rise time	PLL enabled		3		ns
t _F	Input clock fall time	PLL enabled		3		ns
t _{jJITTER}	Input clock jitter				600	ns
t _{cp}	EXTCLK to PIXCLK propagation delay	Nominal voltages, PLL disabled, PIXCLK slew rate = 4	5.3		13.4	ns
t _{RP}	PIXCLK rise time	PCLK slew rate = 6	1.3		4.0	ns
t _{FP}	PIXCLK fall time	PCLK slew rate = 6	1.3		3.9	ns
	PIXCLK duty cycle		40	50	60	%
f _{PIXCLK}	PIXCLK frequency	PIXCLK slew rate = 6, Data slew rate = 7	6		74.25	MHz
t _{PD}	PIXCLK to data valid	PIXCLK slew rate = 6, Data slew rate = 7	-2.5		2	ns
t _{PFH}	PIXCLK to FV HIGH	PIXCLK slew rate = 6, Data slew rate = 7	-2.5		2	ns
t _{PLH}	PIXCLK to LV HIGH	PIXCLK slew rate = 6, Data slew rate = 7	-2.5		2	ns
t _{PFL}	PIXCLK to FV LOW	PIXCLK slew rate = 6, Data slew rate = 7	-2.5		2	ns
t _{PLL}	PIXCLK to LV LOW	PIXCLK slew rate = 6, Data slew rate = 7	-2.5		2	ns
CIN	Input pin capacitance			2.5		pf

Notes:

- 1. Minimum and maximum values are taken at 70°C, 1.7V and -30°C, 1.95V. All values are taken at the 50% transition point. The loading used is 10 pF.
- 2. Jitter from PIXCLK is already taken into account in the data for all of the output parameters.



Table 8: I/O Rise Slew Rate (2.8V VDD_IO)¹

Parallel Slew Rate (R0x306E[15:13])	Conditions	Min	Тур	Max	Units
7	Default	1.50	2.50	3.90	V/ns
6	Default	0.98	1.62	2.52	V/ns
5	Default	0.71	1.12	1.79	V/ns
4	Default	0.52	0.82	1.26	V/ns
3	Default	0.37	0.58	0.88	V/ns
2	Default	0.26	0.40	0.61	V/ns
1	Default	0.17	0.27	0.40	V/ns
0	Default	0.10	0.16	0.23	V/ns

Note: 1. Minimum and maximum values are taken at 70°C, 2.5V and -30°C, 3.1V. The loading used is 10 pF.

Table 9: I/O Fall Slew Rate (2.8V VDD_IO)¹

Parallel Slew Rate (R0x306E[15:13])	Conditions	Min	Тур	Max	Units
7	Default	1.40	2.30	3.50	V/ns
6	Default	0.97	1.61	2.48	V/ns
5	Default	0.73	1.21	1.86	V/ns
4	Default	0.54	0.88	1.36	V/ns
3	Default	0.39	0.63	0.88	V/ns
2	Default	0.27	0.43	0.66	V/ns
1	Default	0.18	0.29	0.44	V/ns
0	Default	0.11	0.17	0.25	V/ns

Note: 1. Minimum and maximum values are taken at 70° C, 2.5V and - 30° C, 3.1V. The loading used is 10 pF.



Table 10: I/O Rise Slew Rate (1.8V VDD_IO)¹

Parallel Slew Rate (R0x306E[15:13])	Conditions	Min	Тур	Max	Units
7	Default	0.57	0.91	1.55	V/ns
6	Default	0.39	0.61	1.02	V/ns
5	Default	0.29	0.46	0.75	V/ns
4	Default	0.22	0.34	0.54	V/ns
3	Default	0.16	0.24	0.39	V/ns
2	Default	0.12	0.17	0.27	V/ns
1	Default	0.08	0.11	0.18	V/ns
0	Default	0.05	0.07	0.10	V/ns

Note: 1. Minimum and maximum values are taken at 70°C, 1,7V and -30°C, 1.95V. The loading used is 10 pF.

Table 11: I/O Fall Slew Rate (1.8V VDD_IO)¹

Parallel Slew Rate (R0x306E[15:13])	Conditions	Min	Тур	Max	Units
7	Default	0.57	0.92	1.55	V/ns
6	Default	0.40	0.64	1.08	V/ns
5	Default	0.31	0.50	0.82	V/ns
4	Default	0.24	0.38	0.61	V/ns
3	Default	0.18	0.27	0.44	V/ns
2	Default	0.13	0.19	0.31	V/ns
1	Default	0.09	0.13	0.20	V/ns
0	Default	0.05	0.08	0.12	V/ns

Notes: 1. Minimum and maximum values are taken at 70°C, 1.7V and -30°C, 1.95V. The loading used is 10 pF.



DC Electrical Characteristics

The DC electrical characteristics are shown in Table 12, Table 13, Table 14, and Table 15.

Table 12: DC Electrical Characteristics

Symbol	Definition	Condition	Min	Тур	Max	Unit
VDD	Core digital voltage		1.7	1.8	1.95	V
VDD_IO	I/O digital voltage		1.7/2.5	1.8/2.8	1.9/3.1	V
VAA	Analog voltage		2.5	2.8	3.1	V
VAA_PIX	Pixel supply voltage		2.5	2.8	3.1	V
VDD_PLL	PLL supply voltage		2.5	2.8	3.1	V
VDD_SLVS	HiSPi supply voltage		0.3	0.4	0.6	V
VIH	Input HIGH voltage		VDD_IO * 0.7	_	_	V
VIL	Input LOW voltage		_	_	VDD_IO * 0.3	V
lin	Input leakage current	No pull-up resistor; Vin = Vdd_IO or DGND	20	_	-	μΑ
Vон	Output HIGH voltage		VDD_IO - 0.3	_	_	V
Vol	Output LOW voltage	VDD_IO = 2.8V	_	_	0.4	V
Іон	Output HIGH current	At specified Voн	-22	_	_	mA
IOL	Output LOW current	At specified Vol	_	_	22	mA

Caution

Stresses greater than those listed in Table 13 may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Table 13: Absolute Maximum Ratings

Symbol	Parameter	Minimum	Maximum	Unit	Symbol
VSUPPLY	Power supply voltage (all supplies)	-0.3	4.5	V	VSUPPLY
ISUPPLY	Total power supply current	_	200	mA	ISUPPLY
IGND	Total ground current	_	200	mA	IGND
VIN	DC input voltage	-0.3	VDD_IO + 0.3	V	Vin
Vout	DC output voltage	-0.3	VDD_IO + 0.3	V	Vout
TsTG ¹	Storage temperature	-40	+85	°C	TsTG ¹

Note: 1. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Table 14: Operating Current Consumption for Parallel Output

VAA = VAA_PIX = VDD_IO = VDD_PLL = 2.8V; VDD= 1.8V; PLL Enabled and PIXCLK = 74.25 MHz; TA = 25°C; CLOAD = 10pF

	Condition	Symbol	Min	Тур	Max	Unit
Digital operating current	Parallel, Streaming, Full resolution 54 fps	IDD1		46	60	mA
I/O digital operating current	Parallel, Streaming, Full resolution 54 fps	IDD_IO		52	_	mA
Analog operating current	Parallel, Streaming, Full resolution 54 fps	IAA		46	55	mA
Pixel supply current	Parallel, Streaming, Full resolution 54 fps	IAA_PIX		7	9	mA
PLL supply current	Parallel, Streaming, Full resolution 54 fps	IDD_PLL		8	10	mA

 Table 15:
 Standby Current Consumption

Analog - VAA + VAA_PIX + VDD_PLL; Digital - VDD + VDD_IO; TA = 25°C

Definition	Condition	Min	Тур	Max	Unit
Hard standby (clock off, driven low)	Analog, 2.8V	-	3	15	μΑ
That distances (Clock off, driver low)	Digital, 1.8V	_	25	80	μΑ
Hard standby (clock on, EXTCLK = 20 MHz)	Analog, 2.8V	-	12	25	μΑ
Tiard Standby (clock on, Extern = 20 Minz)	Digital, 1.8V	_	1.1	1.7	mA
Soft standby (clock off, driven low)	Analog, 2.8V	_	3	15	μΑ
Soft standby (clock off, driver low)	Digital, 1.8V	-	25	80	μΑ
Soft standby (clock on, EXTCLK = 20 MHz)	Analog, 2.8V	_	12	25	μΑ
Soft Stallady (Clock Oil, EXTCER = 20 MHZ)	Digital, 1.8V	-	1.1	1.7	mA

HiSPi Electrical Specifications

The ON Semiconductor AR0134 sensor supports SLVS mode only, and does not have a DLL for timing adjustments. Refer to the High-Speed Serial Pixel (HiSPi) Interface Physical Layer Specification v2.00.00 for electrical definitions, specifications, and timing information. The VDD_SLVS supply in this data sheet corresponds to VDD_TX in the HiSPi Physical Layer Specification. Similarly, VDD is equivalent to VDD_HiSPi as referenced in the specification. The HiSPi transmitter electrical specifications are listed at 700 MHz.

Table 16: Input Voltage and Current (HiSPi Power Supply 0.4 V)

Measurement Conditions: Max Freq 700 MHz

Parameter	Symbol	Min	Тур	Max	Unit
Supply current (PWRHiSPi) (driving 100Ω load)	IDD_SLVS	-	10	15	mA
HiSPi common mode voltage (driving 100Ω load)	Vcmd	VDD_SLVS x 0.45	VDD_SLVS/2	VDD_SLVS x 0.55	V
HiSPi differential output voltage (driving 100Ω load)	Vod	VDD_SLVS x 0.36	VDD_SLVS/2	VDD_SLVS x 0.64	V
Change in Vcм between logic 1 and 0	ΔVcм			25	mV
Change in VOD between logic 1 and 0	Vod			25	mV
Vod noise margin	NM	-		30	%
Difference in VcM between any two channels	ΔVcм			50	mV
Difference in VoD between any two channels	ΔVod			100	mV
Common-mode AC voltage (pk) without VCM cap termination	ΔVcM_ac			50	mV
Common-mode AC voltage (pk) with Vcм cap termination	ΔVcM_ac			30	mV
Max overshoot peak VOD	VoD_ac			1.3 x VoD	V
Max overshoot Vdiff pk-pk	V_{diff_pkpk}			2.6 x VOD	V
Eye Height	V _{eye}	1.4 x Vod			
Single-ended output impedance	Ro	35	50	70	Ω
Output impedance mismatch	ΔRo			20	%

Figure 16: Differential Output Voltage for Clock or Data Pairs

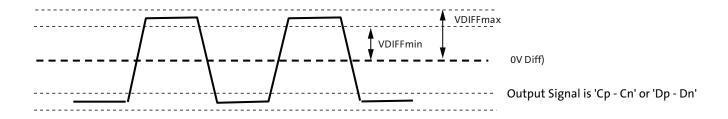


Table 17: Rise and Fall Times

Measurement Conditions: HiSPi Power Supply 0.4V, Max Freq 700 MHz

Parameter	Symbol	Min	Тур	Max	Unit
Data Rate	1/UI	280	-	700	Mb/s
Max setup time from transmitter	TxPRE	0.3	-	-	UI ¹
Max hold time from transmitter	TxPost	0.3	-	_	UI
Rise time (20% - 80%)	RISE	_	0.25UI	_	
Fall time (20% - 80%)	FALL	150ps	0.25 UI	_	
Clock duty	PLL_DUTY	45	50	55	%
Bitrate Period	t _{pw}	1.43		3.57	ns ¹
Eye Width	t _{eye}	0.3			UI ^{1, 2}
Data Total jitter (pk pk)@1e-9	t _{totaljit}			0.2	UI ^{1, 2}
Clock Period Jitter (RMS)	t _{ckjit}			50	ps ²
Clock cycle to cycle jitter (RMS)	t _{cyjit}			100	ps ²
Clock to Data Skew	t _{chskew}	-0.1		0.1	UI ^{1, 2}
PHY-to-PHY Skew	t _{PHYskew}			2.1	UI ^{1, 5}
Mean differential skew	t _{DIFFSKEW}	-100		100	ps ⁶

Notes:

- 1. One UI is defined as the normalized mean time between one edge and the following edge of the clock.
- 2. Taken from 0V crossing point.
- 3. Also defined with a maximum loading capacitance of 10pF on any pin. The loading capacitance may also need to be less for higher bitrates so the rise and fall times do not exceed the maximum 0.3UI.
- 4. The absolute mean skew between the Clock lane and any Data Lane in the same PHY between any edges.
- 5. The absolute mean skew between any Clock in one PHY and any Data lane in any other PHY between any edges.
- 6. Differential skew is defined as the skew between complementary outputs. It is measured as the absolute time between the two complementary edges at mean VCM point.



Figure 17: Eye Diagram for Clock and Data Signals

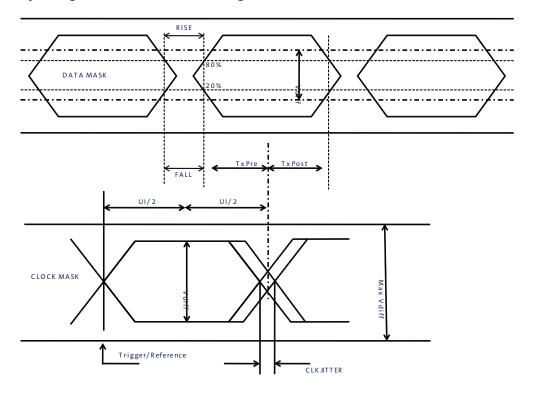
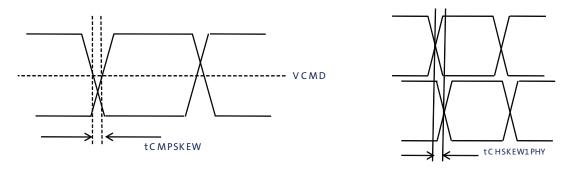


Figure 18: Skew Within the PHY and Output Channels



Power-On Reset and Standby Timing

Power-Up Sequence

The recommended power-up sequence for the AR0134 is shown in Figure 19. The available power supplies (VDD_IO, VDD, VDD_SLVS, VDD_PLL, VAA, VAA_PIX) must have the separation specified below.

- 1. Turn on VDD_PLL power supply.
- 2. After 0–10μs, turn on VAA and VAA_PIX power supply.
- 3. After 0–10µs, turn on VDD_IO power supply.
- 4. After the last power supply is stable, enable EXTCLK.
- 5. If RESET_BAR is in a LOW state, hold RESET_BAR LOW for at least 1ms. If RESET_BAR is in a HIGH state, assert RESET_BAR for at least 1ms.
- 6. Wait 160000 EXTCLKs (for internal initialization into software standby).
- 7. Configure PLL, output, and image settings to desired values.
- 8. Wait 1ms for the PLL to lock.
- 9. Set streaming mode (R0x301a[2] = 1).

Figure 19: Power Up

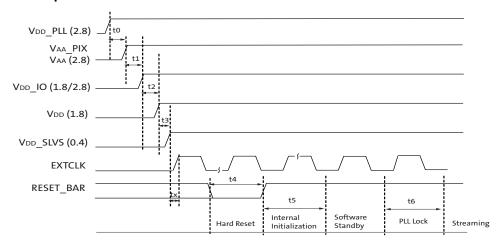


Table 18: Power-Up Sequence

Definition	Symbol	Minimum	Typical	Maximum	Unit
VDD_PLL to VAA/VAA_PIX	t0	0	10	_	μs
VAA/VAA_PIX to VDD_IO	t1	0	10	_	μs
VDD_IO to VDD	t2	0	10	_	μs
VDD to VDD_SLVS	t3	0	10	_	μs
Xtal settle time	tx	_	30 ¹	_	ms
Hard Reset	t4	1 ²	_	_	ms
Internal Initialization	t5	160000	_	_	EXTCLKs
PLL Lock Time	t6	1	_	-	ms

Notes: 1. Xtal settling time is component-dependent, usually taking about 10 – 100 ms.

2. Hard reset time is the minimum time required after power rails are settled. In a circuit where hard reset is held down by RC circuit, then the RC time must include the all power rail settle time and Xtal settle time.



3. It is critical that VDD_PLL is not powered up after the other power supplies. It must be powered before or at least at the same time as the others. If the case happens that VDD_PLL is powered after other supplies then the sensor may have functionality issues and will experience high current draw on this supply.

Power-Down Sequence

The recommended power-down sequence for the AR0134 is shown in Figure 20. The available power supplies (VDD_IO, VDD, VDD_SLVS, VDD_PLL, VAA, VAA_PIX) must have the separation specified below.

- 1. Disable streaming if output is active by setting standby R0x301a[2] = 0
- 2. The soft standby state is reached after the current row or frame, depending on configuration, has ended.
- 3. Turn off VDD SLVS.
- 4. Turn off VDD.
- 5. Turn off VDD IO
- 6. Turn off VAA/VAA_PIX.
- 7. Turn off VDD PLL.

Figure 20: Power Down

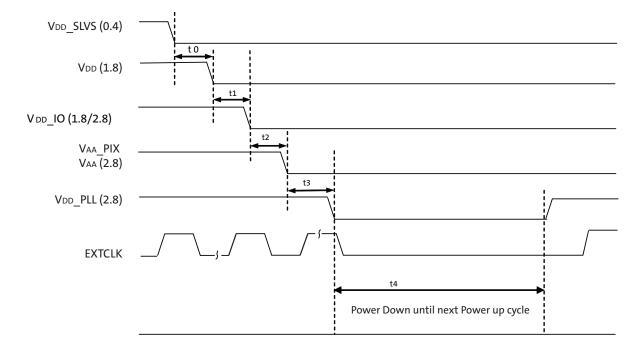


Table 19: Power-Down Sequence

Definition	Symbol	Minimum	Typical	Maximum	Unit
VDD_SLVS to VDD	t0	0	_	_	μS
VDD to VDD_IO	t1	0	_	_	μS
VDD_IO to VAA/VAA_PIX	t2	0	_	_	μS
VAA/VAA_PIX to VDD_PLL	t3	0	_	_	μS
PwrDn until Next PwrUp Time	t4	100	_	_	mS



Note: t4 is required between power down and next power up time; all decoupling caps from regulators must be completely discharged.

Standby Sequence

Figures 21 and 22 show timing diagrams for entering and exiting standby. Delays are shown indicating the last valid register write prior to entering standby as well as the first valid write upon exiting standby. Also shown is timing if the EXTCLK is to be disabled during standby.

Figure 21: Enter Standby Timing

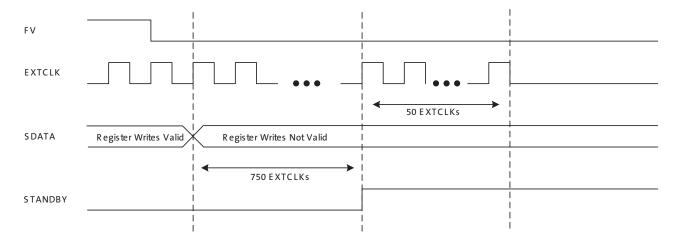


Figure 22: Exit Standby Timing

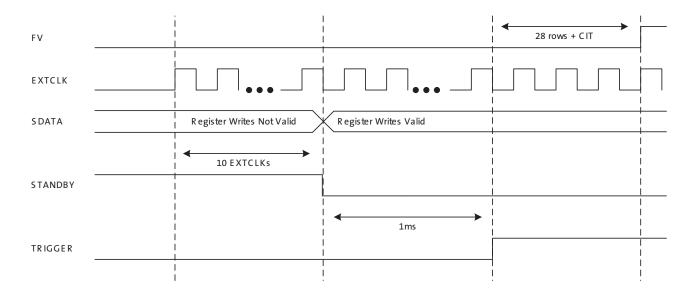




Figure 23: Quantum Efficiency – Monochrome Sensor (Typical)

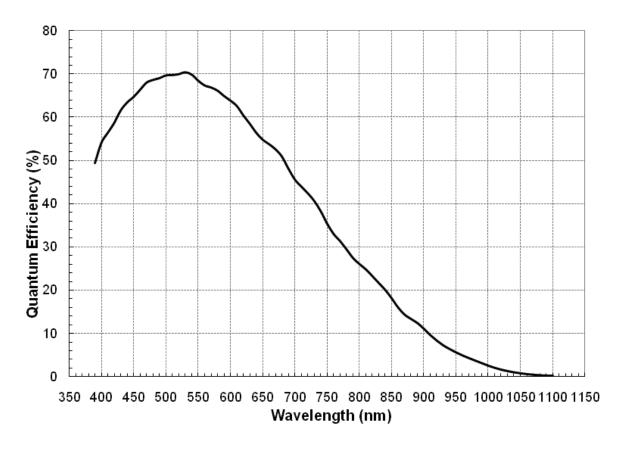


Figure 24: Quantum Efficiency – Color Sensor (Typical)

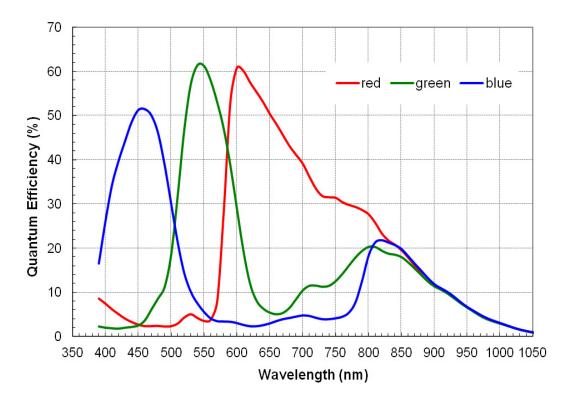
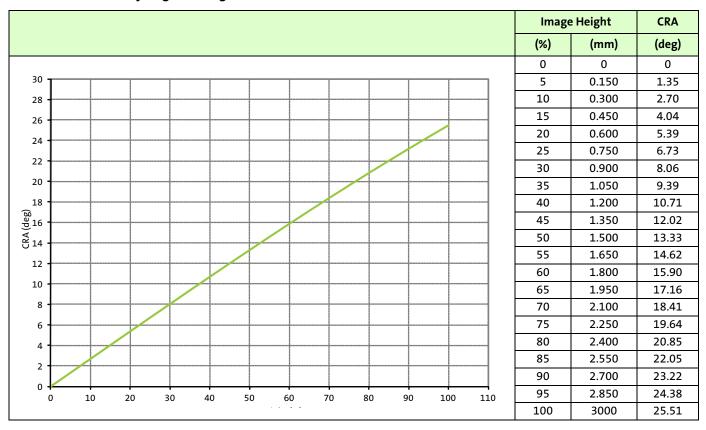




Table 20: Chief Ray Angle - 25deg Mono





Package Dimensions

Figure 25: 63-Ball iBGA Package Outline Drawing

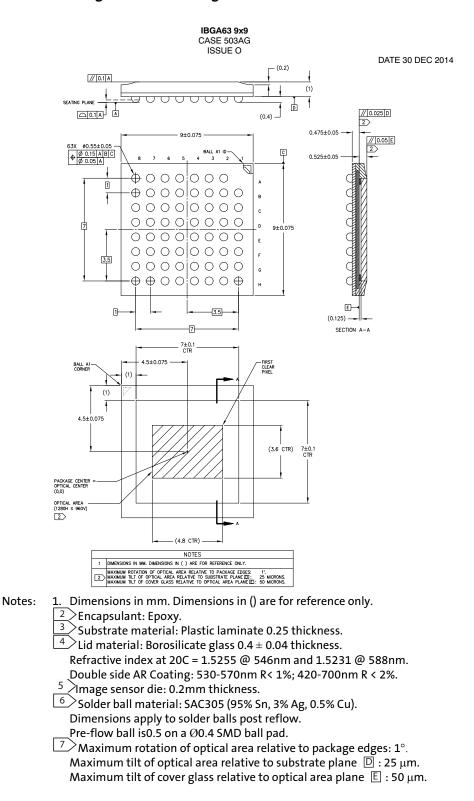
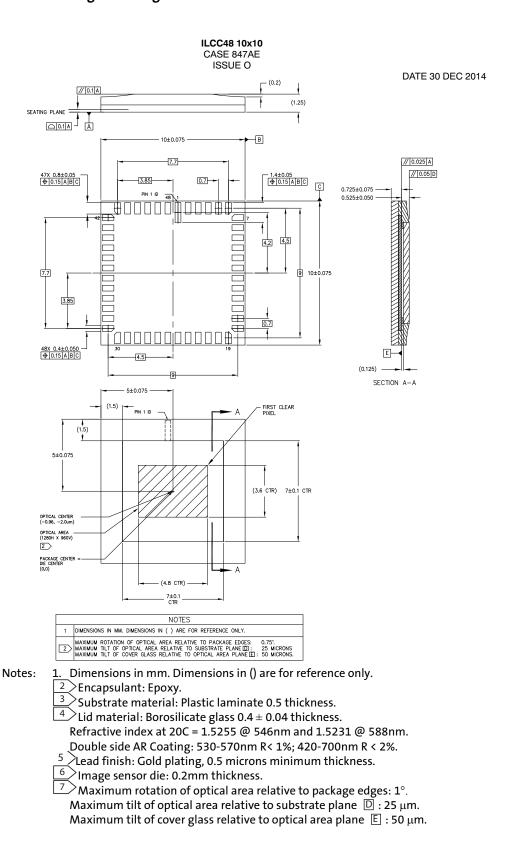




Figure 26: 48-pin iLCC Package Drawing



ON Semiconductor and the ON logo are registered trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries. SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов:
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001:
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: <u>org@eplast1.ru</u>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина,

дом 2, корпус 4, литера А.